

MOSFET

600V CoolMOS™ SJ S7 Power Device

IPT60R065S7 enables the best price performance for low frequency switching applications. CoolMOS™ S7 boasts the lowest $R_{DS(on)}$ values for a HV SJ MOSFET, with distinctive increase of energy efficiency.

CoolMOS™ S7 is optimized for “static switching” and high current applications. It is an ideal fit for solid state relay and circuit breaker designs as well as for line rectification in SMPS and inverter topologies.

Features

- CoolMOS™ S7 technology enables $22\text{m}\Omega$ $R_{DS(on)}$ in the smallest footprint
- Optimized price performance in low frequency switching applications
- High pulse current capability
- Kelvin Source pin improves switching performance at high current
- TOLL package is MSL1 compliant, total Pb-free, has easy visual inspection leads

Benefits

- Minimized conduction losses (eliminate / reduce heat sink)
- Increased system performance
- More compact and easier design
- Lower BOM or/and TCO over prolonged life time

Compared to electromechanical devices:

- Faster switching times
- More reliability and longer system lifetime
- Shock & Vibration resistance
- No contact arcing, bouncing or degradation over life time

Potential applications

- Solid state relays and circuit breakers
- Diode bridge paralleling/replacement for line rectification in high power/performance applications e.g. Computing, Telecom, UPS and Solar

Product validation

Fully qualified according to JEDEC for Industrial Applications

Please note: For paralleling 4pin MOSFET devices the placement of the gate resistor is generally recommended to be on the Driver Source instead of the Gate.

Table 1 Key Performance Parameters

Parameter	Value	Unit
$R_{DS(on),max}$	65	$\text{m}\Omega$
$Q_{g,typ}$	51	nC
V_{SD}	0.82	V
Pulsed I_{SD}, I_{DS}	126	A

Type / Ordering Code	Package	Marking	Related Links
IPT60R065S7	PG-HSOF-8	60R065S7	see Appendix A

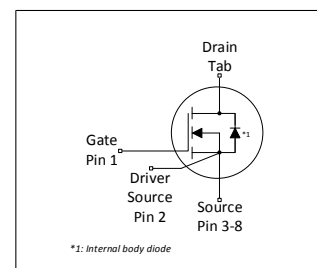


Table of Contents

Description	1
Maximum ratings	3
Thermal characteristics	4
Electrical characteristics	5
Electrical characteristics diagrams	7
Test Circuits	11
Package Outlines	12
Appendix A	13
Revision History	14
Trademarks	14
Disclaimer	14

1 Maximum ratings

at $T_j = 25^\circ\text{C}$, unless otherwise specified

Table 2 Maximum ratings

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain current rating	I_D	-	-	8	A	$T_C=140^\circ\text{C}$ Current is limited by $T_{j\text{max}} = 150^\circ\text{C}$; Lower case temp does increase current capability
Pulsed drain current ¹⁾	$I_{D,\text{pulse}}$	-	-	126	A	$T_C=25^\circ\text{C}$
Avalanche energy, single pulse	E_{AS}	-	-	97	mJ	$I_D=2.3\text{A}$; $V_{DD}=50\text{V}$; see table 10
Avalanche current, single pulse	I_{AS}	-	-	2.3	A	-
MOSFET dv/dt ruggedness ²⁾	dv/dt	-	-	20	V/ns	$V_{DS}= 0\text{V to } 300\text{V}$
Gate source voltage (static)	V_{GS}	-20	-	20	V	static
Gate source voltage (dynamic)	V_{GS}	-30	-	30	V	AC ($f>1\text{ Hz}$)
Power dissipation	P_{tot}	-	-	167	W	$T_C=25^\circ\text{C}$
Storage temperature	T_{stg}	-55	-	150	$^\circ\text{C}$	-
Operating junction temperature	T_j	-55	-	150	$^\circ\text{C}$	-
Mounting torque	-	-	-	n.a.	Ncm	-
Diode forward current rating	I_S	-	-	8	A	$T_C=140^\circ\text{C}$ Current is limited by $T_{j\text{max}} = 150^\circ\text{C}$; Lower case temp does increase current capability
Diode pulse current ¹⁾	$I_{S,\text{pulse}}$	-	-	126	A	$T_C=25^\circ\text{C}$
Reverse diode dv/dt ³⁾	dv/dt	-	-	5	V/ns	$V_{DS}=0\text{ to } 300\text{V}$, $I_{SD}\leq 8\text{A}$, $T_j=25^\circ\text{C}$ see table 8
Maximum diode commutation speed	di/dt	-	-	1000	A/ μs	$V_{DS}=0\text{ to } 300\text{V}$, $I_{SD}\leq 8\text{A}$, $T_j=25^\circ\text{C}$ see table 8
Insulation withstand voltage	V_{ISO}	-	-	n.a.	V	V_{rms} , $T_C=25^\circ\text{C}$, $t=1\text{min}$

¹⁾ Pulse width t_p limited by $T_{j\text{max}}$

²⁾ The dv/dt has to be limited by appropriate gate resistor

³⁾ Identical low side and high side switch

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Thermal resistance, junction - case	R_{thJC}	-	-	0.75	°C/W	-
Thermal resistance, junction - ambient	R_{thJA}	-	-	62	°C/W	device on PCB, minimal footprint
Thermal resistance, junction - ambient for SMD version	R_{thJA}	-	35	45	°C/W	Device on 40mm*40mm*1.5mm epoxy PCB FR4 with 6cm ² (one layer, 70µm thickness) copper area for drain connection and cooling. PCB is vertical without air stream cooling.
Soldering temperature, wave- & reflow soldering allowed	T_{sold}	-	-	260	°C	reflow MSL1

3 Electrical characteristics

at $T_j=25^\circ\text{C}$, unless otherwise specified

Table 4 Static characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Drain-source breakdown voltage ¹⁾	$V_{(BR)DSS}$	600	-	-	V	$V_{GS}=0V, I_D=1mA$
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{DS}=V_{GS}, I_D=0.49mA$
Zero gate voltage drain current	I_{DSS}	-	-	1	μA	$V_{DS}=600V, V_{GS}=0V, T_j=25^\circ\text{C}$ $V_{DS}=600V, V_{GS}=0V, T_j=150^\circ\text{C}$
Gate-source leakage current	I_{GSS}	-	-	100	nA	$V_{GS}=20V, V_{DS}=0V$
Drain-source on-state resistance	$R_{DS(on)}$	-	0.059 0.137	0.065	Ω	$V_{GS}=12V, I_D=8A, T_j=25^\circ\text{C}$ $V_{GS}=12V, I_D=8A, T_j=150^\circ\text{C}$
Gate resistance	R_G	-	0.80	-	Ω	$f=1\text{MHz}$, open drain

Table 5 Dynamic characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Input capacitance	C_{iss}	-	1932	-	pF	$V_{GS}=0V, V_{DS}=300V, f=250\text{kHz}$
Output capacitance	C_{oss}	-	32	-	pF	$V_{GS}=0V, V_{DS}=300V, f=250\text{kHz}$
Effective output capacitance, energy related ²⁾	$C_{o(er)}$	-	104	-	pF	$V_{GS}=0V, V_{DS}=0$ to 300V
Effective output capacitance, time related ³⁾	$C_{o(tr)}$	-	904	-	pF	$I_D=\text{constant}, V_{GS}=0V, V_{DS}=0$ to 300V
Output charge	Q_{oss}	-	271	-	nC	$V_{GS}=0V, V_{DS}=0$ to 300V
Turn-on delay time	$t_{d(on)}$	-	15	-	ns	$V_{DD}=300V, V_{GS}=13V, I_D=8A, R_G=10\Omega$; see table 9
Rise time	t_r	-	5	-	ns	$V_{DD}=300V, V_{GS}=13V, I_D=8A, R_G=10\Omega$; see table 9
Turn-off delay time	$t_{d(off)}$	-	100	-	ns	$V_{DD}=300V, V_{GS}=13V, I_D=8A, R_G=10\Omega$; see table 9
Fall time	t_f	-	9	-	ns	$V_{DD}=300V, V_{GS}=13V, I_D=8A, R_G=10\Omega$; see table 9

Table 6 Gate charge characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Gate to source charge	Q_{gs}	-	11	-	nC	$V_{DD}=300V, I_D=8A, V_{GS}=0$ to 12V
Gate to drain charge	Q_{gd}	-	17	-	nC	$V_{DD}=300V, I_D=8A, V_{GS}=0$ to 12V
Gate charge total	Q_g	-	51	-	nC	$V_{DD}=300V, I_D=8A, V_{GS}=0$ to 12V
Gate plateau voltage	$V_{plateau}$	-	5.4	-	V	$V_{DD}=300V, I_D=8A, V_{GS}=0$ to 12V

¹⁾ For applications with applied blocking voltage >70% of the specified blocking voltage, we recommend to use next higher voltage class. For assessment please contact local Infineon sales office.

²⁾ $C_{o(er)}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 300V

³⁾ $C_{o(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 300V

Table 7 Reverse diode characteristics

Parameter	Symbol	Values			Unit	Note / Test Condition
		Min.	Typ.	Max.		
Diode forward voltage	V_{SD}	-	0.82	-	V	$V_{GS}=0V, I_F=8A, T_j=25^\circ C$
Reverse recovery time	t_{rr}	-	310	-	ns	$V_R=300V, I_F=8A, di_F/dt=100A/\mu s$; see table 8
Reverse recovery charge	Q_{rr}	-	3.9	-	μC	$V_R=300V, I_F=8A, di_F/dt=100A/\mu s$; see table 8
Peak reverse recovery current	I_{rrm}	-	27	-	A	$V_R=300V, I_F=8A, di_F/dt=100A/\mu s$; see table 8

4 Electrical characteristics diagrams

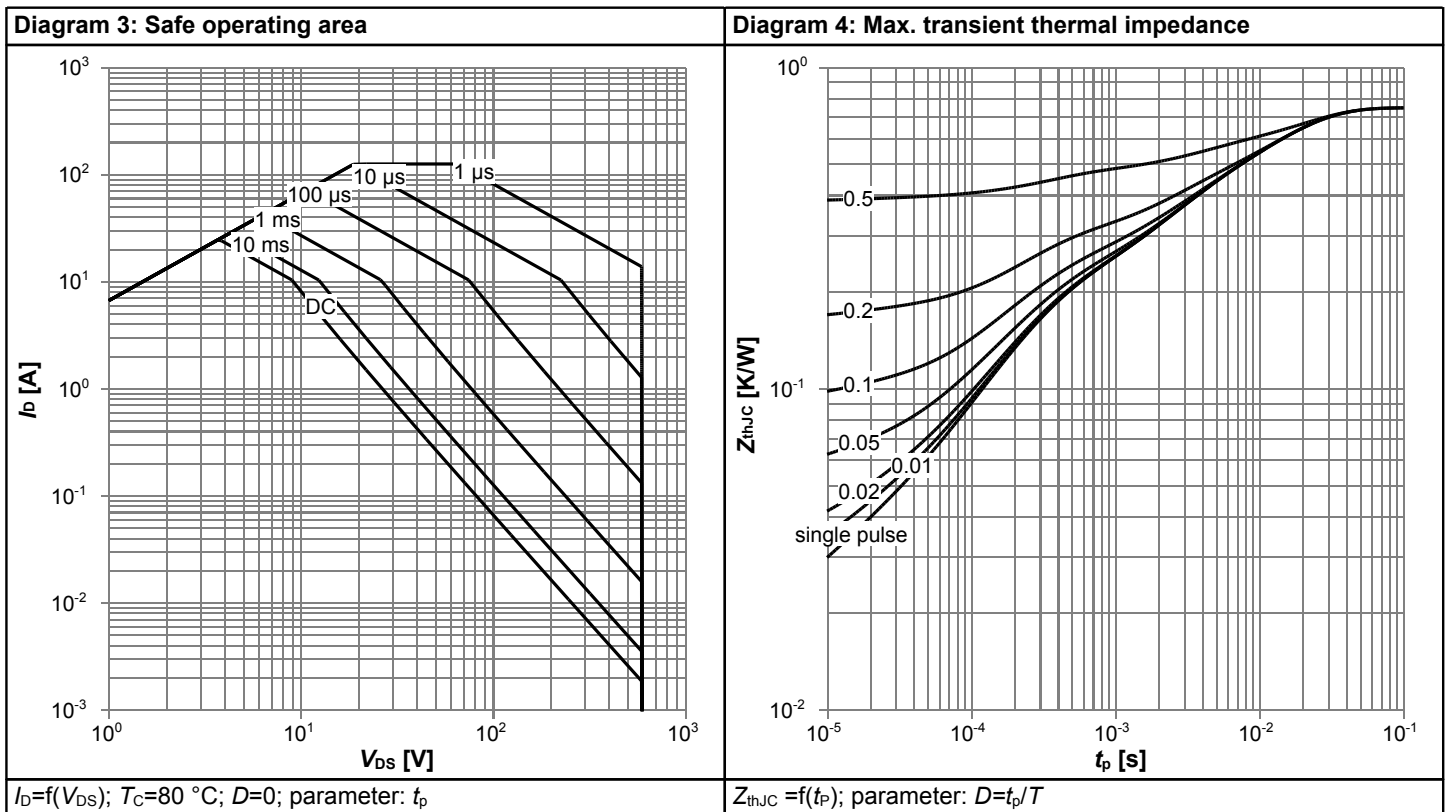
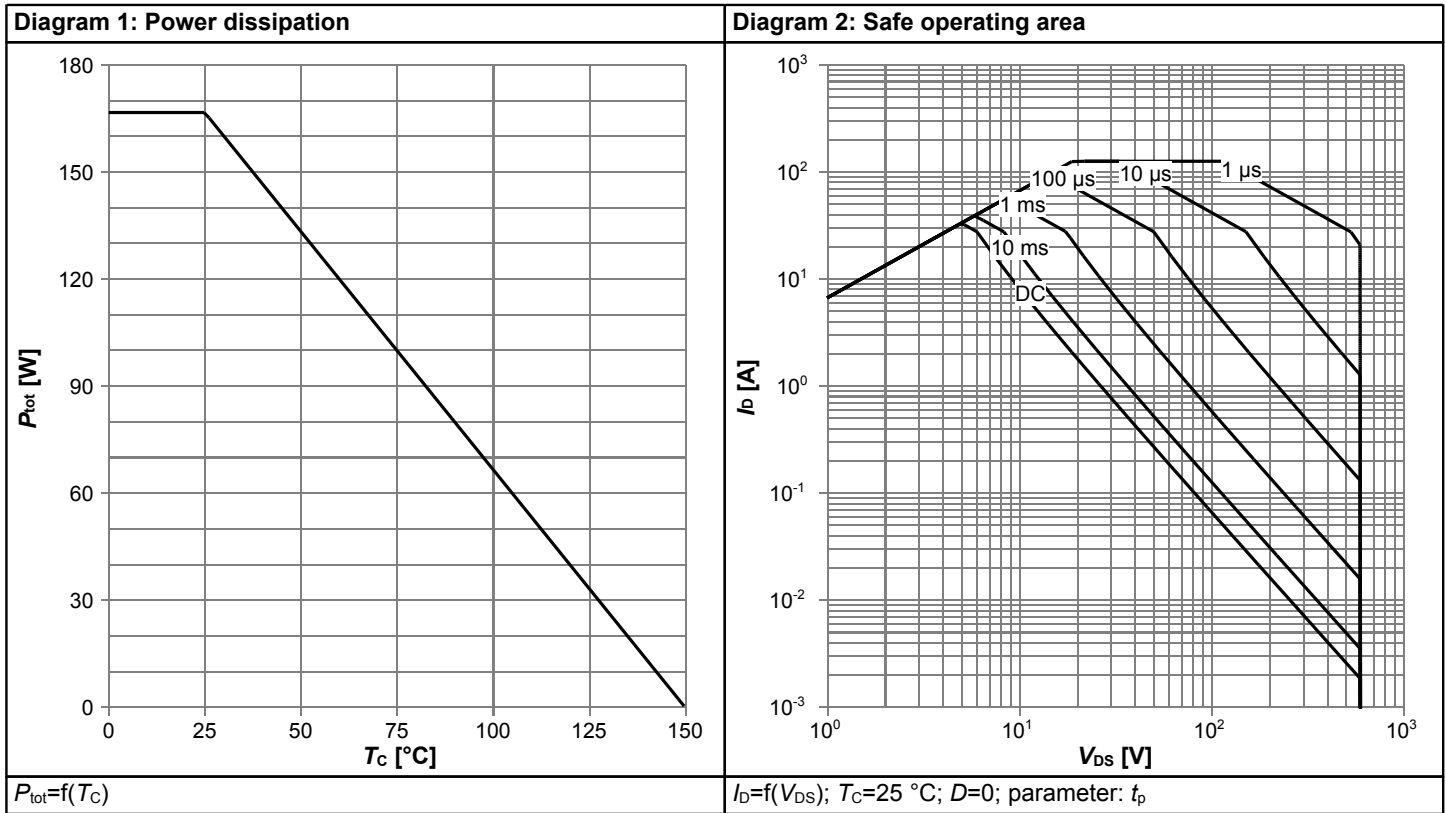
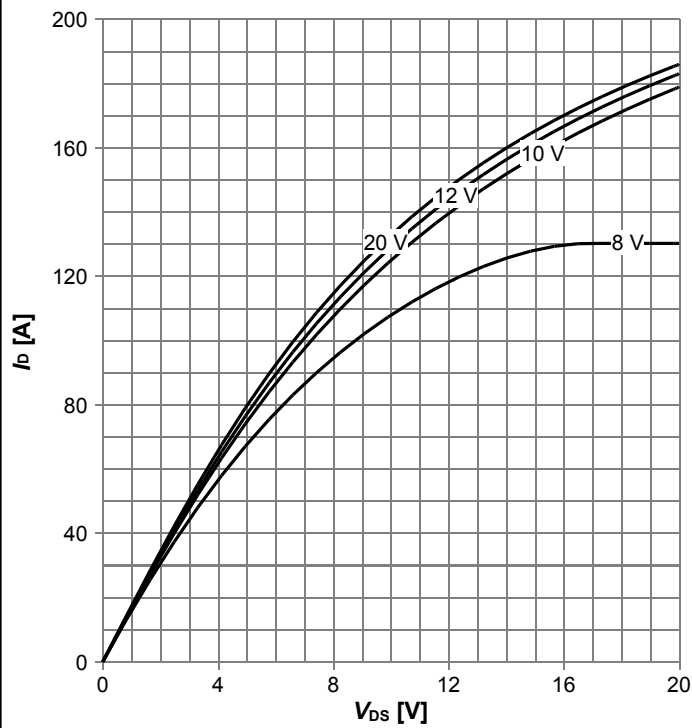
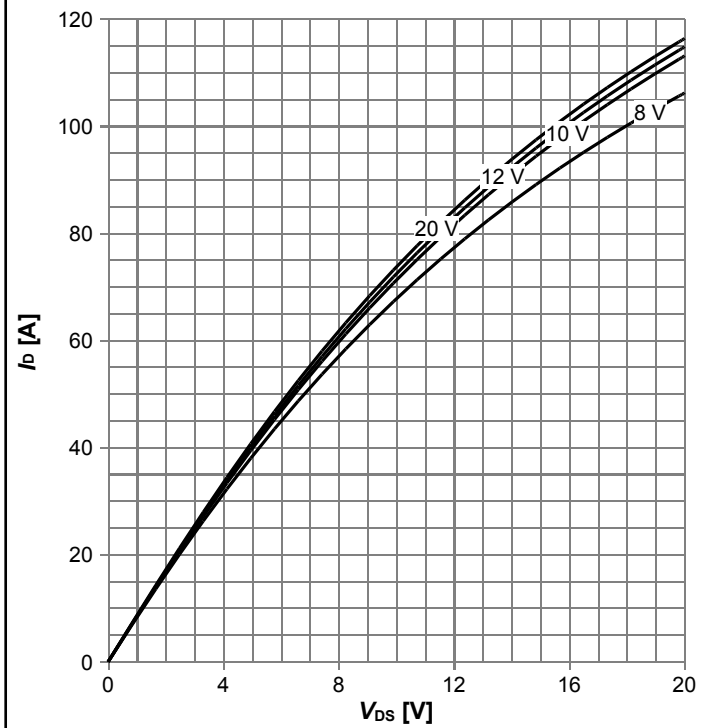


Diagram 5: Typ. output characteristics



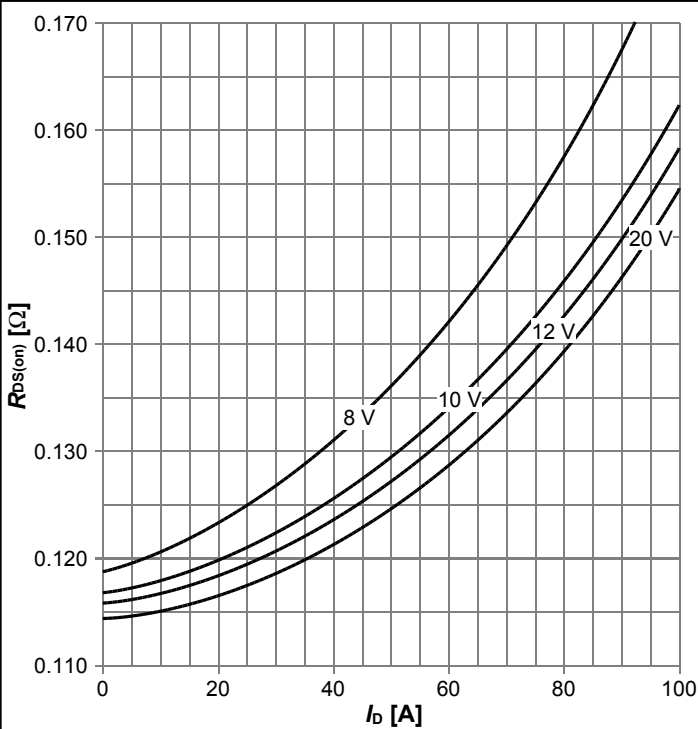
$I_D = f(V_{DS})$; $T_j = 25\text{ °C}$; parameter: V_{GS}

Diagram 6: Typ. output characteristics



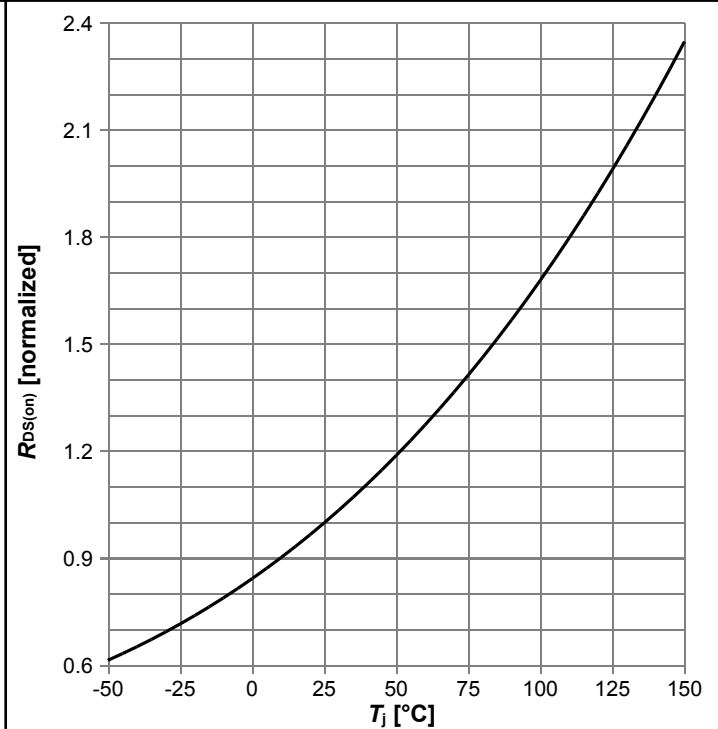
$I_D = f(V_{DS})$; $T_j = 125\text{ °C}$; parameter: V_{GS}

Diagram 7: Typ. drain-source on-state resistance



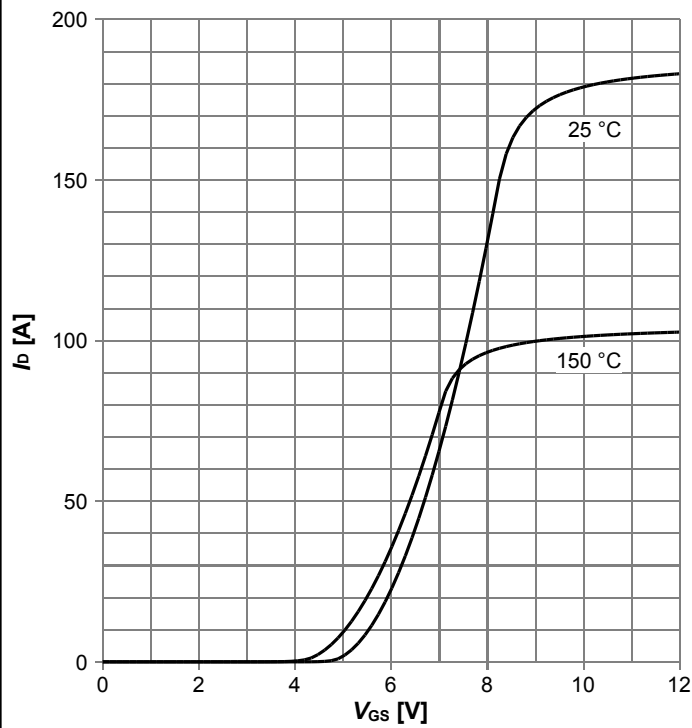
$R_{DS(on)} = f(I_D)$; $T_j = 125\text{ °C}$; parameter: V_{GS}

Diagram 8: Drain-source on-state resistance



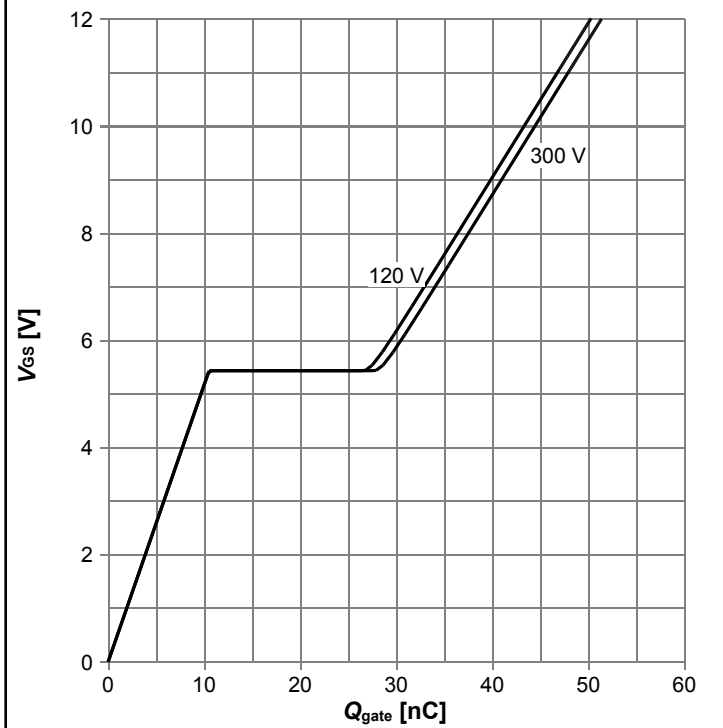
$R_{DS(on)} = f(T_j)$; $I_D = 8.0\text{ A}$; $V_{GS} = 12\text{ V}$

Diagram 9: Typ. transfer characteristics



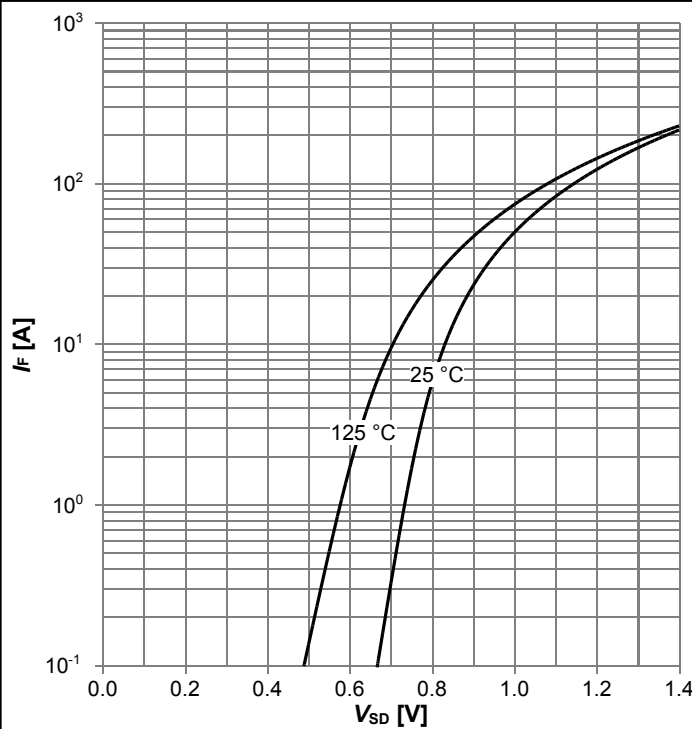
$I_D=f(V_{GS}); V_{DS}=20V$; parameter: T_j

Diagram 10: Typ. gate charge



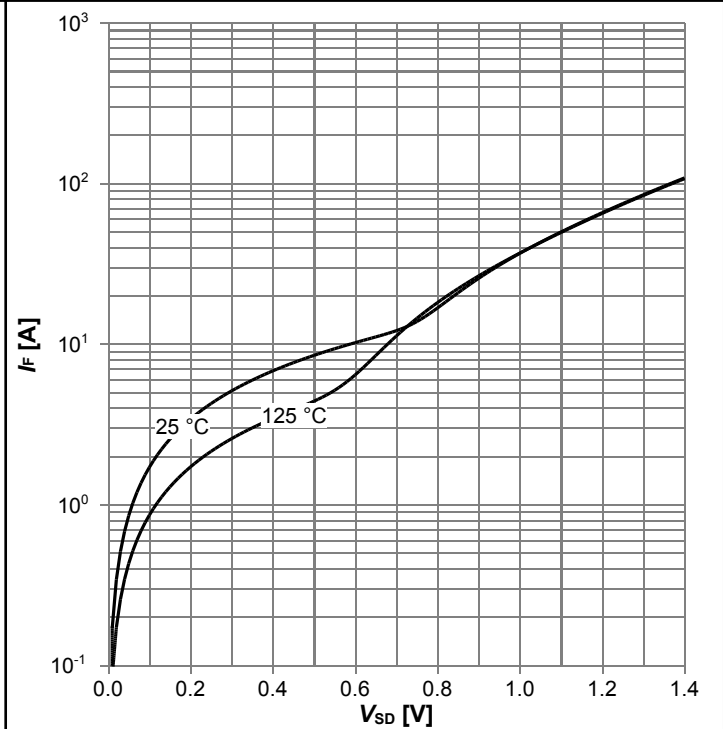
$V_{GS}=f(Q_{gate}); I_D=8.0$ A pulsed; parameter: V_{DD}

Diagram 11: Forward characteristics of reverse diode



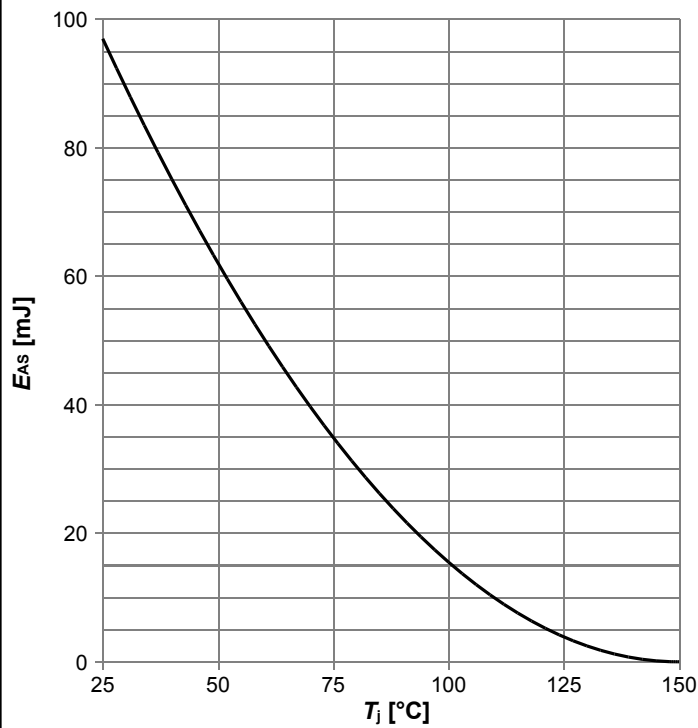
$I_F=f(V_{SD}); V_{GS}=0$ V; parameter: T_j

Diagram 12: Forward characteristics of reverse diode



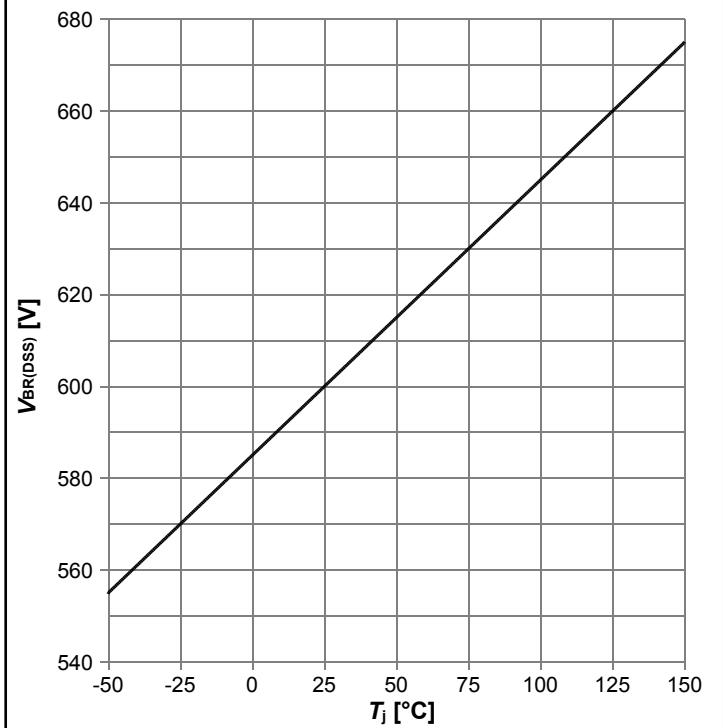
$I_F=f(V_{SD}); V_{GS}=12$ V; parameter: T_j

Diagram 13: Avalanche energy



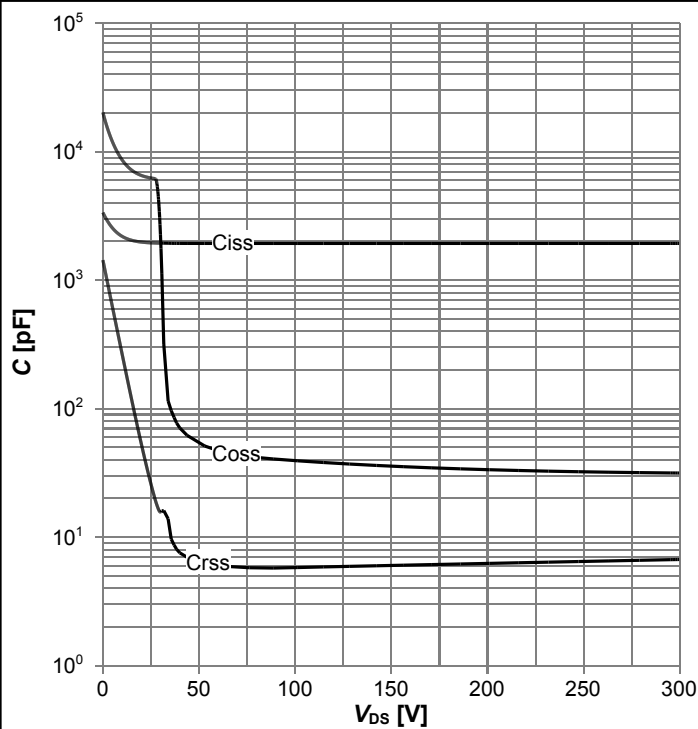
$E_{AS}=f(T_j)$; $I_D=2.3$ A; $V_{DD}=50$ V

Diagram 14: Drain-source breakdown voltage



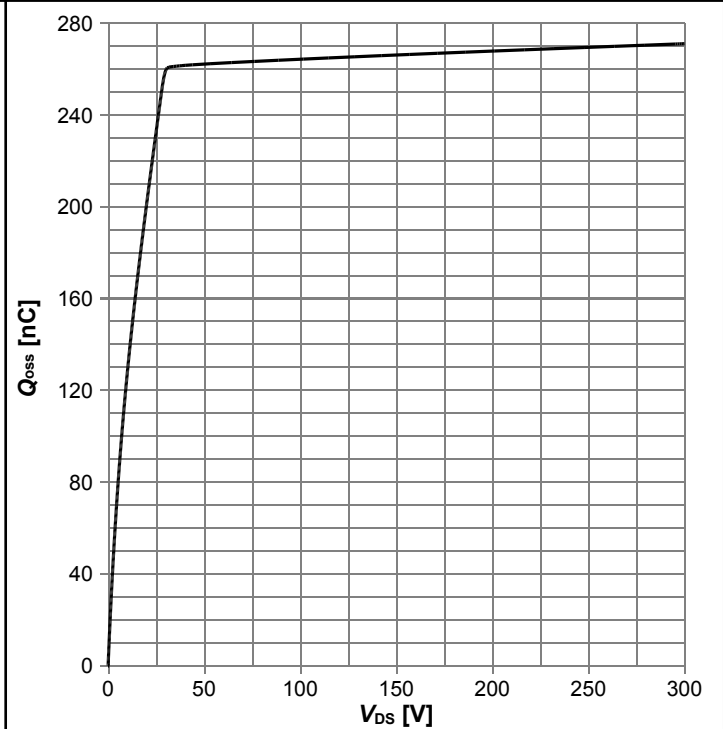
$V_{BR(DSS)}=f(T_j)$; $I_D=1$ mA

Diagram 15: Typ. capacitances



$C=f(V_{DS})$; $V_{GS}=0$ V; $f=250$ kHz

Diagram 17: Typ. Q_oss output charge



$Q_{oss}=f(V_{DS})$; $V_{GS}=0$ V

5 Test Circuits

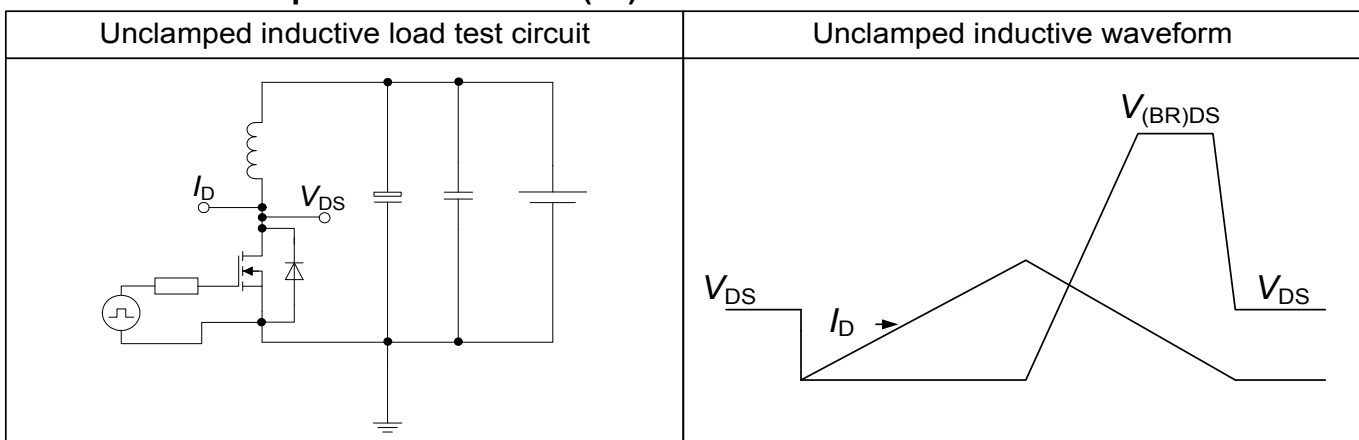
Table 8 Diode characteristics



Table 9 Switching times (ss)



Table 10 Unclamped inductive load (ss)



6 Package Outlines



Figure 1 Outline PG-HSOF-8, dimensions in mm/inches

7 Appendix A

Table 11 Related Links

- IFX CoolMOS S7 Webpage: www.infineon.com
- IFX CoolMOS S7 application note: www.infineon.com
- IFX CoolMOS S7 simulation model: www.infineon.com
- IFX Design tools: www.infineon.com

Revision History

IPT60R065S7

Revision: 2019-05-07, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)
2.0	2019-05-07	Release of final version

Trademarks

All referenced product or service names and trademarks are the property of their respective owners.

We Listen to Your Comments

Any information within this document that you feel is wrong, unclear or missing at all? Your feedback will help us to continuously improve the quality of this document. Please send your proposal (including a reference to this document) to:

erratum@infineon.com

Published by

Infineon Technologies AG
81726 München, Germany
© 2019 Infineon Technologies AG
All Rights Reserved.

Legal Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics ("Beschaffungsgarantie").

With respect to any examples, hints or any typical values stated herein and/or any information regarding the application of the product, Infineon Technologies hereby disclaims any and all warranties and liabilities of any kind, including without limitation warranties of non-infringement of intellectual property rights of any third party.

In addition, any information given in this document is subject to customer's compliance with its obligations stated in this document and any applicable legal requirements, norms and standards concerning customer's products and any use of the product of Infineon Technologies in customer's applications.

The data contained in this document is exclusively intended for technically trained staff. It is the responsibility of customer's technical departments to evaluate the suitability of the product for the intended application and the completeness of the product information given in this document with respect to such application.

Information

For further information on technology, delivery terms and conditions and prices please contact your nearest Infineon Technologies Office (www.infineon.com).

Warnings

Due to technical requirements, components may contain dangerous substances. For information on the types in question, please contact the nearest Infineon Technologies Office.

The Infineon Technologies component described in this Data Sheet may be used in life-support devices or systems and/or automotive, aviation and aerospace applications or systems only with the express written approval of Infineon Technologies, if a failure of such components can reasonably be expected to cause the failure of that life-support, automotive, aviation and aerospace device or system or to affect the safety or effectiveness of that device or system. Life support devices or systems are intended to be implanted in the human body or to support and/or maintain and sustain and/or protect human life. If they fail, it is reasonable to assume that the health of the user or other persons may be endangered.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

[Infineon:](#)

[IPT60R065S7XTMA1](#) [KITACTBRD60R065S7TOBO1](#)